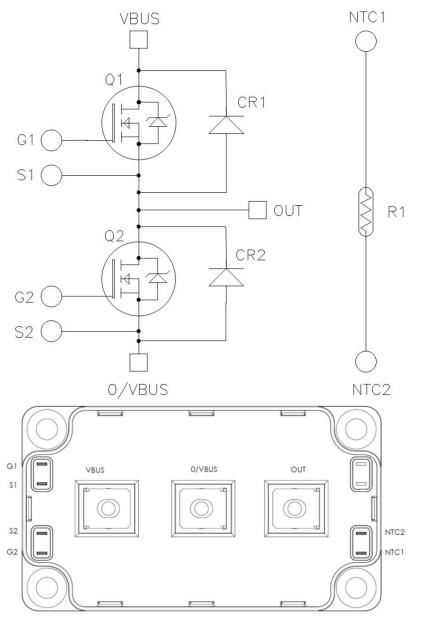


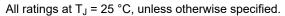
MSCSM70AM025CT6AG

Phase Leg SiC Power Module

Product Overview

The MSCSM70AM025CT6AG device is a phase leg 700 V, 689 A silicon carbide (SiC) power module.





Caution: These devices are sensitive to electrostatic discharge. Proper handling procedures must be followed.

Features

The following are key features of the MSCSM70AM025CT6AG device:

- SiC Schottky Diode
 - Zero reverse recovery
 - Zero forward recovery
 - Temperature independent switching behavior
 - Positive temperature coefficient on VF
- SiC Power MOSFET
 - Low R_{DS(on)}
 - High temperature performance
 - Kelvin source for easy drive
- Low stray inductance
- M5 power connectors
- Internal thermistor for temperature monitoring
- Aluminum nitride (AIN) substrate for improved thermal performance

Benefits

The following are benefits of the MSCSM70AM025CT6AG device:

- High efficiency converter
- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction-to-case thermal resistance
- RoHS compliant

Application

The MSCSM70AM025CT6AG device is designed for the following applications:

- Welding converters
- Switched mode power supplies
- Uninterruptible power supplies
- EV motor and traction drive

1. Electrical Specifications

This section provides the electrical specifications of the MSCSM70AM025CT6AG device.

1.1 SiC MOSFET Characteristics

The following table lists the absolute maximum ratings per SiC MOSFET of the MSCSM70AM025CT6AG device.

Symbol	Parameter		Maximum Ratings	Unit
V _{DSS}	Drain-Source vol	age	700	V
I _D	Continuous	T _C = 25 °C	689 ¹	А
	drain current	T _C = 80 °C	548 ¹	
I _{DM}	Pulsed drain curr	ent	1380	
V _{GS}	Gate-Source volt	age	-10/25	V
R _{DS(on)}	Drain-Source ON	resistance	3.2	mΩ
P _D	Power dissipation	T _C = 25 °C	1882	W

Table 1-1. Absolute Maximum Ratings per SiC MOSFET

Note: 1. Specification of SiC MOSFET device but output current must be limited due to size of power connectors. The following table lists the electrical characteristics per SiC MOSFET of the MSCSM70AM025CT6AG device.

Table 1-2. Electrical Characteristics per SiC MOSFET

Symbol	Characteristics	Test Conditions		Min	Тур	Max	Unit
I _{DSS}	Zero gate voltage drain current	V _{GS} = 0 V; V _{DS} = 7	700 V			600	μA
R _{DS(on)}	Drain-Source	V _{GS} = 20 V	T _J = 25 °C		2.5	3.2	mΩ
	on resistance	I _D = 240 A	T _J = 175 °C		3.2		
V _{GS(th)}	Gate threshold voltage	$V_{GS} = V_{DS}, I_D = 24$	mA	1.9	2.4	—	V
I _{GSS}	Gate–Source leakage current	V _{GS} = 20 V, V _{DS} =	0 V	_	_	600	nA

MSCSM70AM025CT6AG

Electrical Specifications

The following table lists the dynamic characteristics per SiC MOSFET of the MSCSM70AM025CT6AG device.

Symbol	Characteristics	Test Conditions		Min	Тур	Max	Unit
C _{iss}	Input capacitance	V _{GS} = 0 V		—	27	_	nF
C _{oss}	Output capacitance	V _{DS} = 700 V		_	3	_	
C _{rss}	Reverse transfer capacitance	f = 1 MHz			0.17	-	
Qg	Total gate charge	V_{GS} = -5 V/20 V		_	1290	_	nC
Q _{gs}	Gate-Source charge	V _{Bus} = 470 V		_	348		
Q _{gd}	Gate-Drain charge	I _D = 240 A		_	210		
T _{d(on)}	Turn-on delay time	V_{GS} = -5 V/20 V		_	78	_	ns
Tr	Rise time	V _{Bus} = 400 V		—	125	_	
T _{d(off)}	Turn-off delay time	I _D = 480 A; T _J = 1	50 °C		214		
T _f	Fall time	R _{G(ON)} = 4.7 Ω; R	_{G(OFF)} = 2.7 Ω	—	92	_	
Eon	Turn-on energy	V _{GS} = -5/20 V	T _J = 150 °C	_	6.1		mJ
E _{off}	Turn-off energy	V_{Bus} = 400 V I _D = 480 A R _{G(ON)} = 4.7 Ω R _{G(OFF)} = 2.7 Ω	T _J = 150 °C	_	10.5	-	mJ
R _{Gint}	Internal gate resistanc	e		_	0.95	_	Ω
R _{thJC}	Junction-to-case thern	nal resistance		_	—	0.08	°C/W

Table 1-3.	Dynamic	Characteristics	per SiC	MOSFET
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The following table lists the body diode ratings and characteristics per SiC MOSFET of the MSCSM70AM025CT6AG device.

Table 1-4. Body Diode Ratings and Characteristics per SiC MOSFET

Symbol	Characteristics	Test Conditions	Min	Тур	Max	Unit
V _{SD}	Diode forward	V_{GS} = 0 V; I _{SD} = 240 A	—	3.4	—	V
	voltage	V_{GS} = -5 V; I_{SD} = 240 A	—	3.8	—	
t _{rr}	Reverse recovery time	I _{SD} = 240 A; V _{GS} = -5 V V _R = 400 V; di _F /dt = 6000 A/μs		40	—	ns
Q _{rr}	Reverse recovery charge		—	1.9	—	μC
I _{rr}	Reverse recovery current		—	89	—	A

Electrical Specifications

1.2 SiC Schottky Diode Ratings and Characteristics per SiC Diode

The following table lists the SiC diode ratings and characteristics per SiC diode of MSCSM70AM025CT6AG device.

Symbol	Characteristics	Test Conditions		Min	Тур	Max	Unit
V _{RRM}	Peak repetitive revers	e voltage		—	—	700	V
I _{RRM}	Reverse leakage	V _R =700 V	T _J = 25 °C	—	90	1200	μA
	current		T _J = 175 °C	—	1500	_	
I _F	DC forward current	_	T _C = 65 °C	—	300	—	A
V _F	Diode forward	I _F = 300 A	T _J = 25 °C	—	1.5	1.8	V
	voltage		T _J = 175 °C	—	1.9	—	
Q _C	Total capacitive charge	V _R = 400 V	_	_	798	_	nC
С	Total capacitance	f = 1 MHz, V _F	_R = 200 V	—	1488	—	pF
		f = 1 MHz, V _R = 400 V		—	1296	—	
R _{thJC}	Junction-to-case therr	Junction-to-case thermal resistance			—	0.167	°C/W

Table 1-5. SiC Schottky Diode Ratings and Characteristics

Electrical Specifications

1.3 Thermal and Package Characteristics

The following table lists the thermal and package characteristics of MSCSM70AM025CT6AG device.

Symbol	Characteristics	6		Min	Max	Unit
V _{ISOL}	RMS isolation v	oltage, any termi	inal to case	4000	-	V
	t =1 min, 50 Hz/	60 Hz				
TJ	Operating juncti	on temperature i	range	-40	175	°C
T _{JOP}	Recommended switching condit	junction tempera tions	ature under	-40	T _{Jmax} –25	
T _{STG}	Storage temper	ature range		-40	125	_
T _C	Operating case	temperature		-40	125	
Torque	Mounting	To heatsink	M6	3	5	N.m
	torque	For terminals	M5	2	3.5	
Wt	Package weight			_	300	g

Table 1-6. Thermal and Package Characteristics

1.4 Temperature Sensor NTC

The following table lists the temperature sensor NTC. See APT0406 Application Note for more information.

Table 1-7. Temperature Sensor NTC

Symbol	Characteristics	;	Min	Тур	Мах	Unit
R ₂₅	Resistance at 2	5 °C	_	50	—	kΩ
$\Delta R_{25}/R_{25}$	_		_	5	_	%
B _{25/85}	T ₂₅ = 298.15 K			3952		К
$\Delta B/B$	—	T _C = 100 °C	_	4	_	%

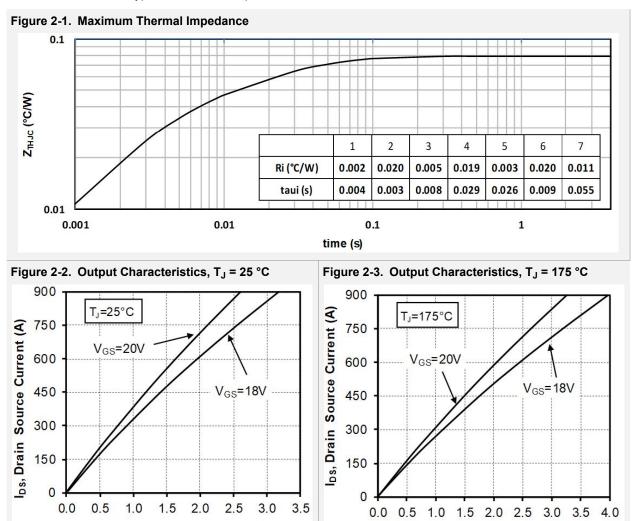
$$R_{T} = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]}$$
 T: Thermistor temperature
R_T: Thermistor value at T

V_{DS}, Drain Source Voltage (V)

2. Typical SiC MOSFET Performance Curve

V_{DS}, Drain Source Voltage (V)

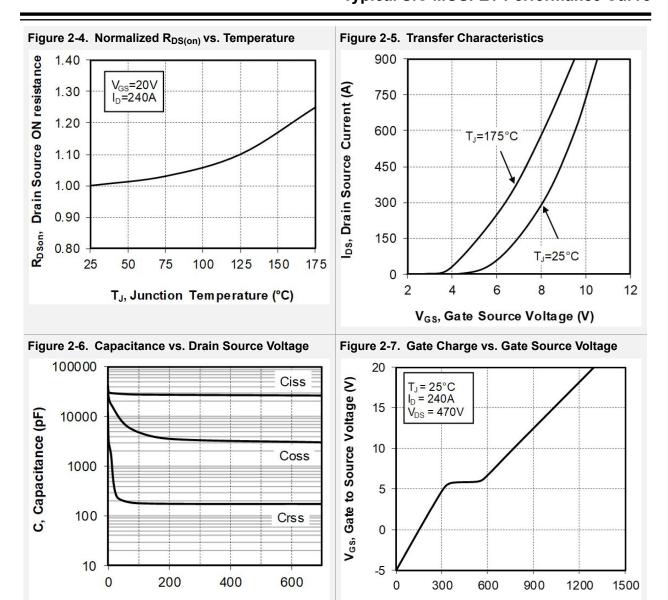
This section shows the typical SiC MOSFET performance curves of the MSCSM70AM025CT6AG device.





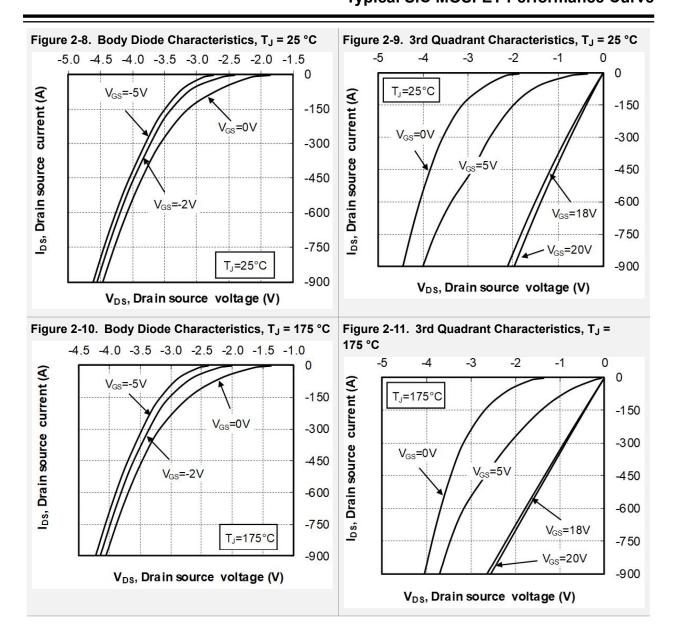
MSCSM70AM025CT6AG Typical SiC MOSFET Performance Curve

Gate Charge (nC)



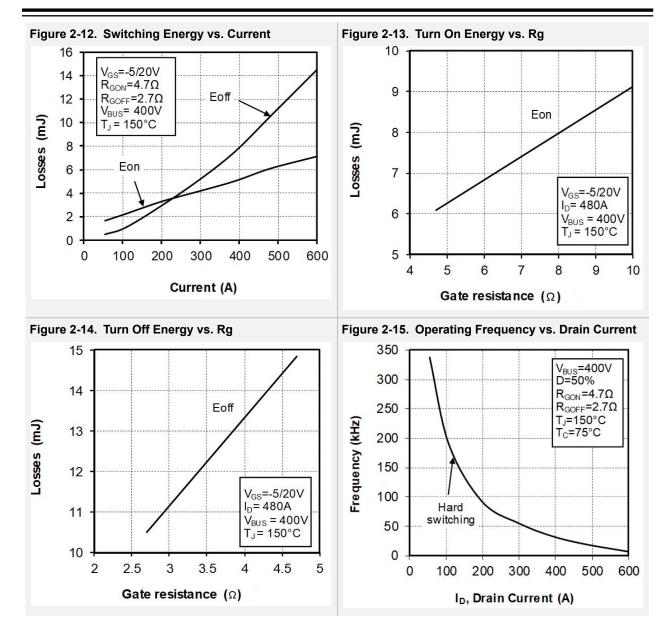
V_{DS}, Drain source Voltage (V)

MSCSM70AM025CT6AG Typical SiC MOSFET Performance Curve



MSCSM70AM025CT6AG

Typical SiC MOSFET Performance Curve



Typical SiC Diode Performance Curve

3. **Typical SiC Diode Performance Curve**

This section shows the typical SiC diode performance curves of MSCSM70AM025CT6AG device.

TJ=175°C

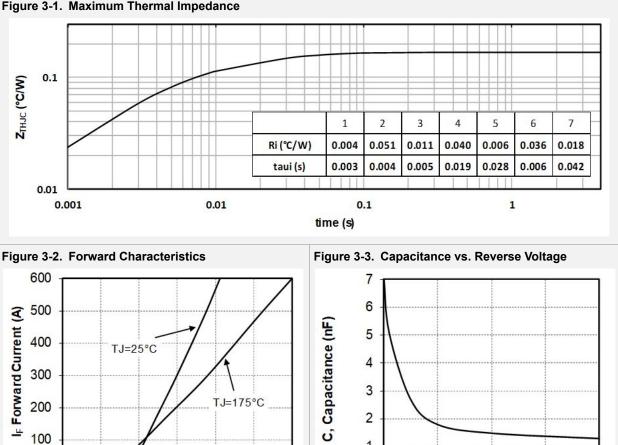
2.5

3

1.5

V_F Forward Voltage (V)

2



3

2

1

0

0

100

200

V_R Reverse Voltage

300

400

Figure 3-1. Maximum Thermal Impedance

100

0

0

0.5

1

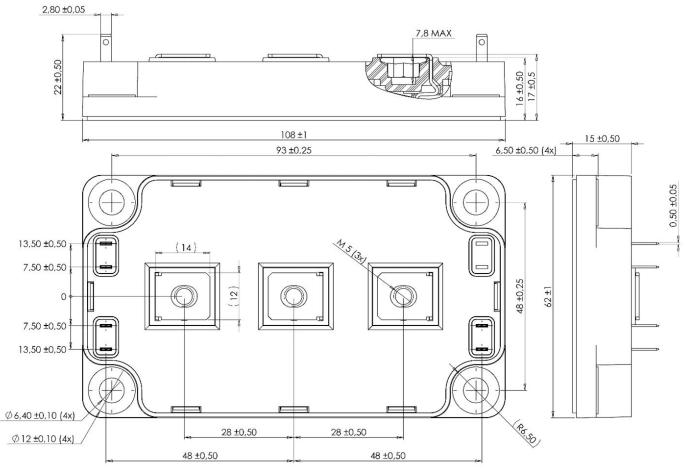
4. Package Specifications

The following section shows the package specification of MSCSM70AM025CT6AG device.

4.1 Package Outline

The following figure shows the package outline drawing of MSCSM70AM025CT6AG device. The dimensions are in millimeters. See *Application Note APT0601*—Mounting instructions for SP6 power modules for more information.

Figure 4-1. Package Outline Drawing



5. Revision History

Revision	Date	Description
A	11/2020	Revision A is the latest publication of this document. The following is the summary of changes:
		The document was updated to Microchip template.
		Document ID is changed to DS00003749.

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